



SPN2302

N-Channel Enhancement Mode MOSFET

DESCRIPTION

The SPN2302 is the N-Channel logic enhancement mode power field effect transistors are produced using high cell density , DMOS trench technology.

This high density process is especially tailored to minimize on-state resistance.

These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and other battery powered circuits, and low in-line power loss are needed in a very small outline surface mount package.

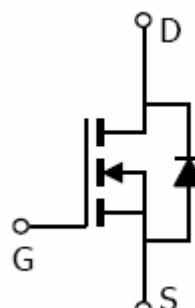
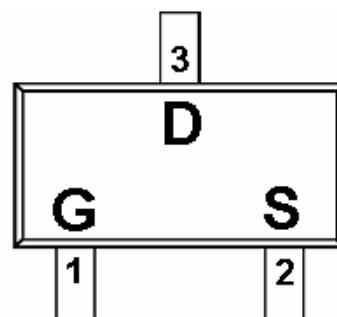
FEATURES

- ◆ 20V/3.6A,R_{DS(ON)}= 80mΩ@V_{GS}=4.5V
- ◆ 20V/3.1A,R_{DS(ON)}= 95mΩ@V_{GS}=2.5V
- ◆ Super high density cell design for extremely low R_{DS (ON)}
- ◆ Exceptional on-resistance and maximum DC current capability
- ◆ SOT-23-3L package design

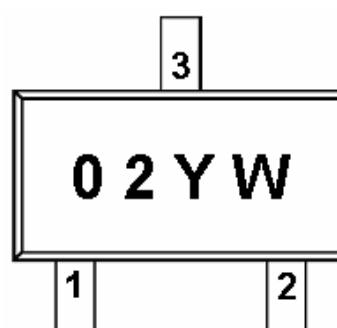
APPLICATIONS

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC
- LCD Display inverter

PIN CONFIGURATION(SOT-23-3L)



PART MARKING



Y : Year Code
W : Week Code



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PIN DESCRIPTION

Pin	Symbol	Description
1	G	Gate
2	S	Source
3	D	Drain

ORDERING INFORMATION

Part Number	Package	Part Marking
SPN2302S23RG	SOT-23-3L	02YW

Week Code : A ~ Z(1 ~ 26) ; a ~ z(27 ~ 52)

SPN2302S23RG : Tape Reel ; Pb – Free

ABSOULTE MAXIMUM RATINGS

(TA=25 Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V _{DSS}	20	V
Gate –Source Voltage	V _{GSS}	±12	V
Continuous Drain Current(T _J =150)	TA=25	ID	2.8
	TA=70		2.2
Pulsed Drain Current	I _{DM}	10	A
Continuous Source Current(Diode Conduction)	I _S	1.6	A
Power Dissipation	TA=25	P _D	1.25
	TA=70		0.8
Operating Junction Temperature	T _J	150	
Storage Temperature Range	T _{STG}	-55/150	
Thermal Resistance-Junction to Ambient	R _{θJA}	100	/W



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ELECTRICAL CHARACTERISTICS

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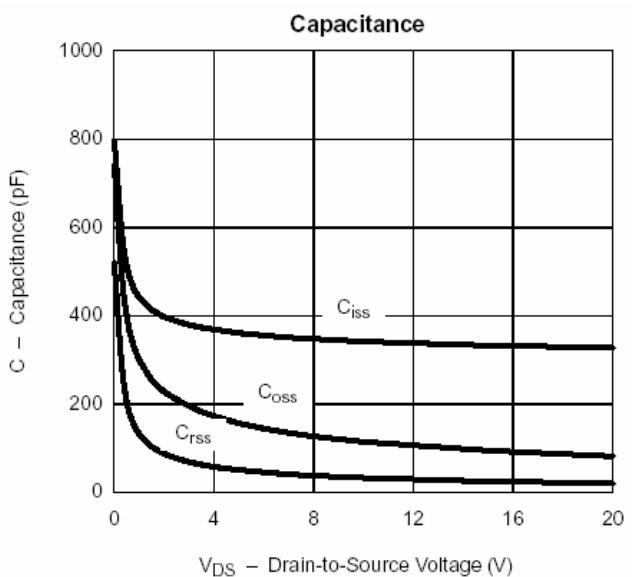
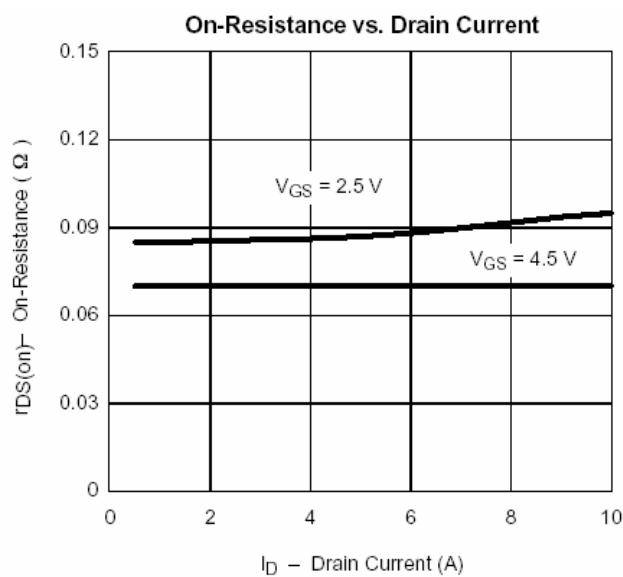
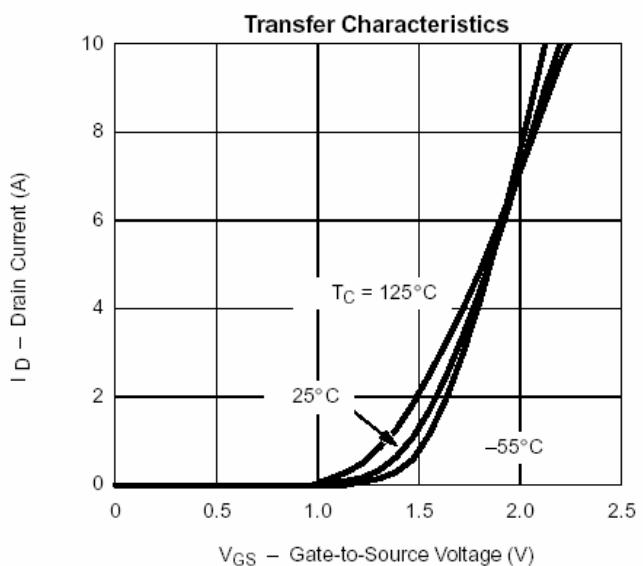
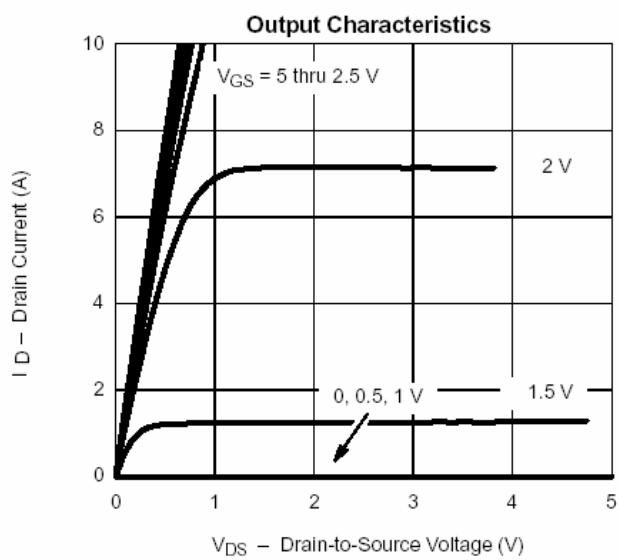
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V(BR)DSS	VGS=0V, ID=250uA	20			V
Gate Threshold Voltage	VGS(th)	VDS=VGS, ID=250uA	0.45		1.2	
Gate Leakage Current	IGSS	VDS=0V, VGS=±12V			±100	nA
Zero Gate Voltage Drain Current	IDSS	VDS=20V, VGS=0V			1	
		VDS=20V, VGS=0V TJ=55			10	uA
On-State Drain Current	ID(on)	VDS 5V, VGS=4.5V	6			A
		VDS 5V, VGS=2.5V	4			
Drain-Source On-Resistance	RDS(on)	VGS=4.5V, ID=3.6A		0.050	0.080	Ω
		VGS=2.5V, ID=3.1A		0.070	0.095	
Forward Transconductance	gfs	VDS=5V, ID=3.6A		10		S
Diode Forward Voltage	VSD	Is=1.6A, VGS=0V		0.85	1.2	V
Dynamic						
Total Gate Charge	Qg	VDS=10V, VGS=4.5V ID=3.6A		5.4	10	
Gate-Source Charge	Qgs			0.65		nC
Gate-Drain Charge	Qgd			1.4		
Input Capacitance	Ciss	VDS=10V, VGS=0V f=1MHz		340		
Output Capacitance	Coss			115		pF
Reverse Transfer Capacitance	Crss			33		
Turn-On Time	td(on)	VDD=10V, RL=5.5Ω ID=3.6A, VGEN=4.5V RG=6Ω		12	25	
	tr			36	60	ns
Turn-Off Time	td(off)			34	60	
	tf			10	25	



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TYPICAL CHARACTERISTICS

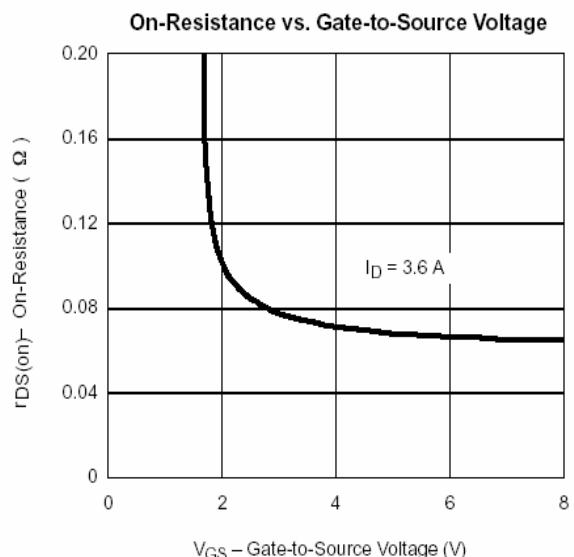
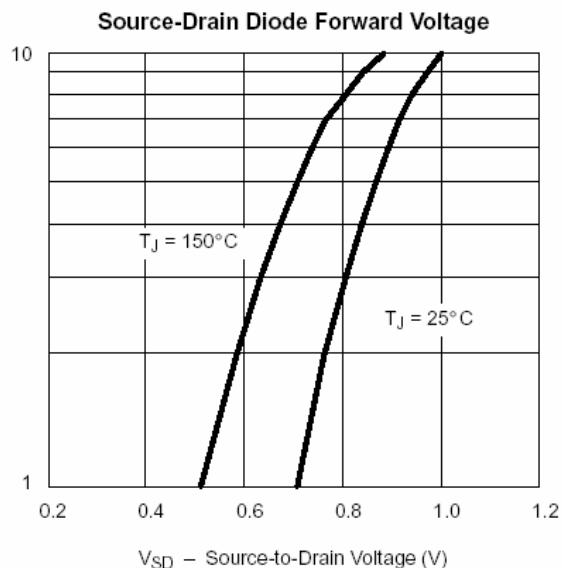
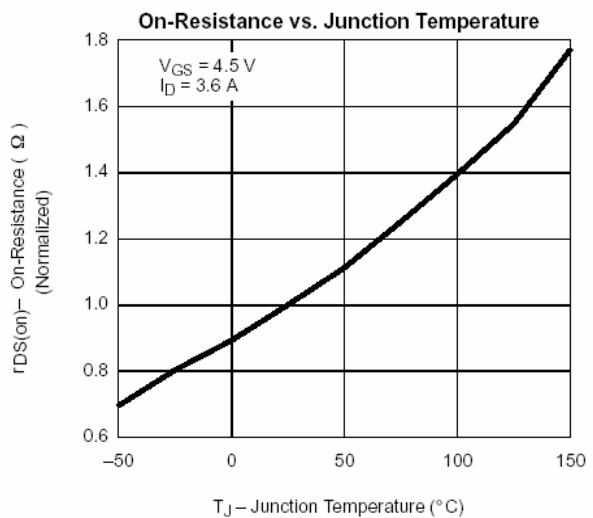
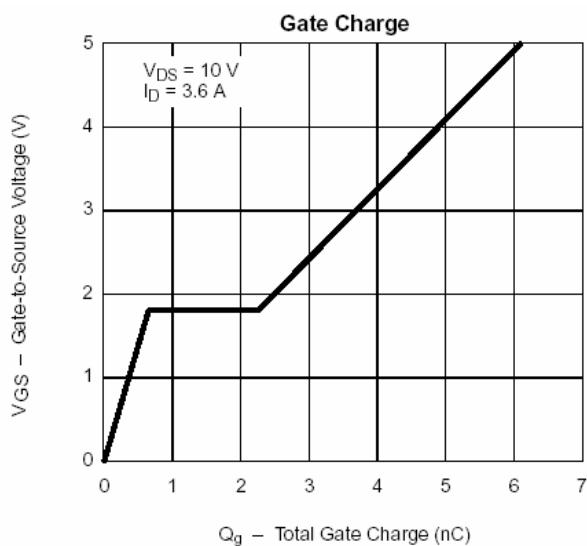




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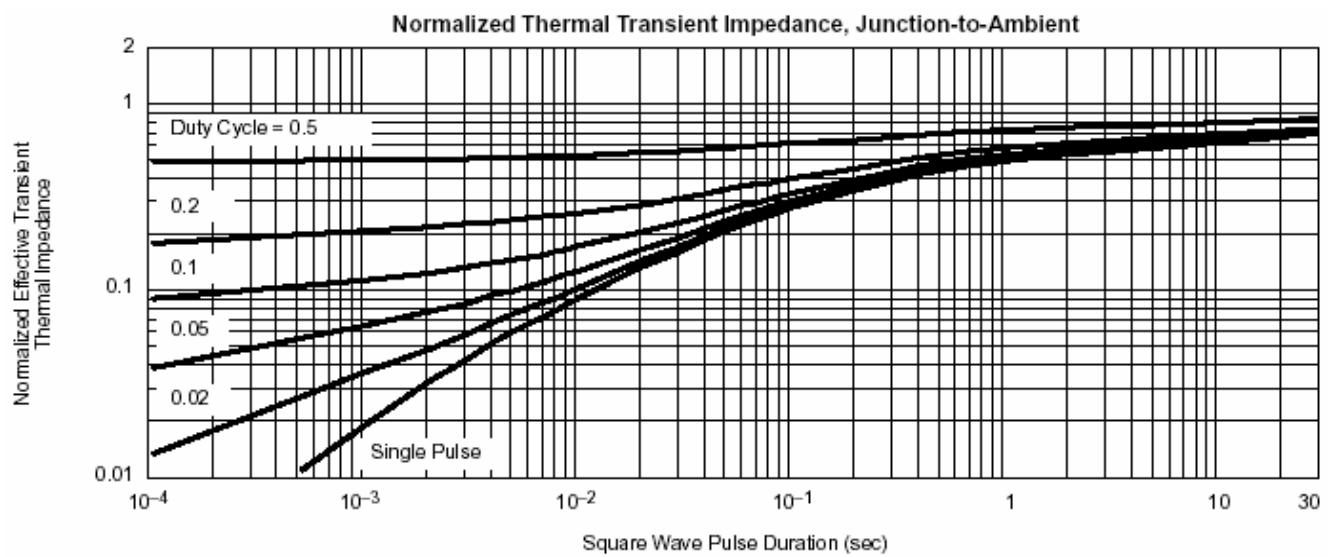
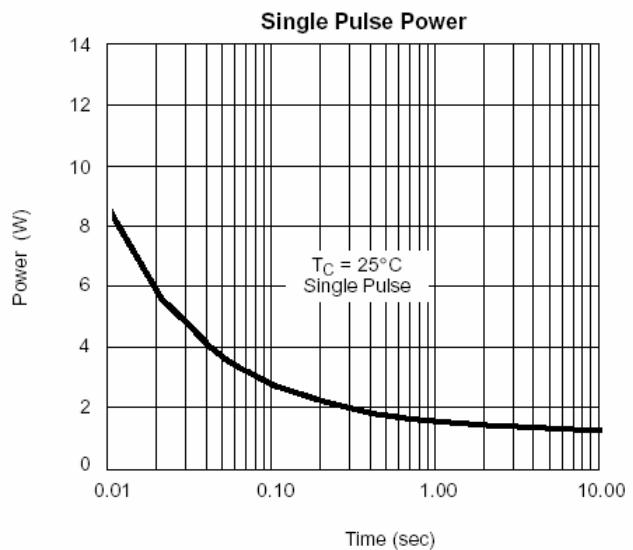
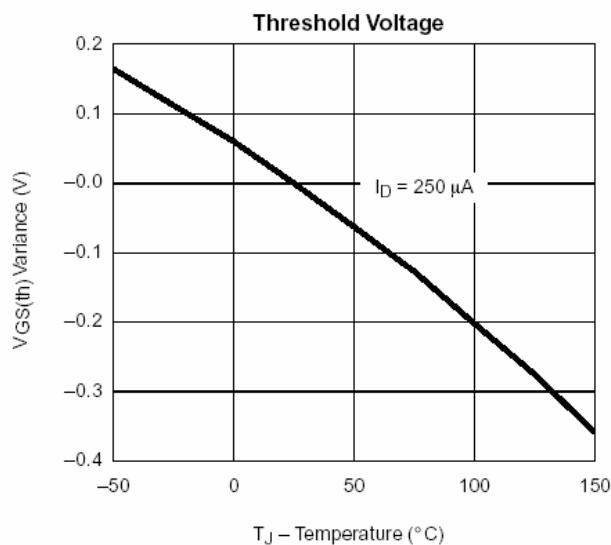




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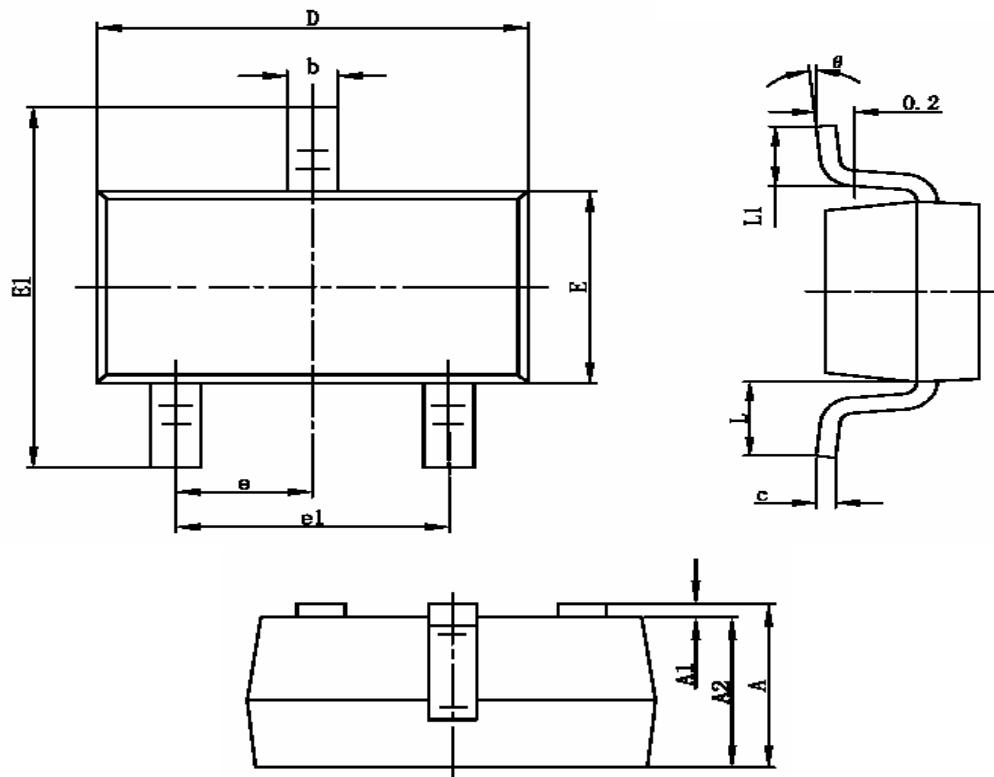




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SOT-23-3L PACKAGE OUTLINE



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.400	0.012	0.016
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950TYP		0.037TYP	
e1	1.800	2.000	0.071	0.079
L	0.700REF		0.028REF	
L1	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°



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SYNC Power Corporation

9F-5, No.3-2, Park Street

NanKang District (NKSP), Taipei, Taiwan, 115, R.O.C

Phone: 886-2-2655-8178

Fax: 886-2-2655-8468

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